



PATENT

Case Docket No. TOYAM83.001APC

Date: November 8, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : Yamashita, et al.
Appl. No. : 10/019,753
Filed : March 5, 2002
For : LOW-HYGROSCOPICITY LOW-
BIREFRINGENCE RESIN
COMPOSITIONS, MOLDING
MATERIAL OBTAINED THEREFROM,
SHEET OR FILM AND OPTICAL PART
Group Art Unit : 1713
Class/Sub-Class : 525-210000
Examiner : Lee, Rip A.

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

November 8, 2004

(Date)

Che S. Chereskin

Che Swyden Chereskin, Ph.D., Reg. No. 41,466

TRANSMITTAL LETTER

MAIL STOP ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing is the Issue Fee for the above-identified application:

- (X) Form PTOL-85.
- (X) A check in the amount of \$1,400 to cover the issue fee and advanced order of copies is enclosed.
- (X) Information Disclosure Statement, Form PTO-1449 and three (3) references.
- (X) A check in the amount of \$180 as set forth in 37 C.F.R. § 1.17(p).
- (X) The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Account No. 11-1410.

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(X) Return prepaid postcard.



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Agent of Record

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